

IS32SE5117

16-CH PROGRAMMABLE CAPACITIVE TOUCH SENSOR

February 2021

GENERAL DESCRIPTION

IS32SE5117 is an ultra-low power, 16-channel capacitive touch controller. The controller allows sleep mode (under 20uA) and uses auto detection for wakeup. It also provides a shield output to increase moisture immunity. Built-in hardware monitors and calibrates the environment to prevent false triggers.

A host MCU is required to communicate with IS32SE5117. An on-chip I²C slave controller with 400kHz capability and programmable slave addresses serves as the communication port for the host MCU. An interrupt, INTB, can be configured so it is generated when a trigger event (touch or release) occurs. Trigger or clear condition can be configured by setting the interrupt register.

IS32SE5117 is available in Wettable flank QFN-24 package. It operates from 2.7V to 5.5V over the temperature range of -40°C to +125°C.

FEATURES

- 16-channel capacitive touch controller with readable key value
- Touch threshold setting for individual key
- Optional multiple-key function
- Press and hold function
- Automatic calibration
- Individual key calibration
- Interrupt output with auto-clear and repeating
- Auto sleep mode for extremely low power
- Keys wake up from sleep mode
- Shield output shared with touch key channels
- Buzzer/Melody Generator shared with touch key channels
- 400kHz fast-mode I²C interface
- Operating temperature between -40°C ~ +125°C
- Wettable flank QFN-24 package
- AEC-Q100 Qualified

APPLICATIONS

- Automotive HMI of air conditioner
- Automotive infotainment panel
- Automotive ambient lighting control

TYPICAL APPLICATION CIRCUIT (Wettable flank QFN-24)

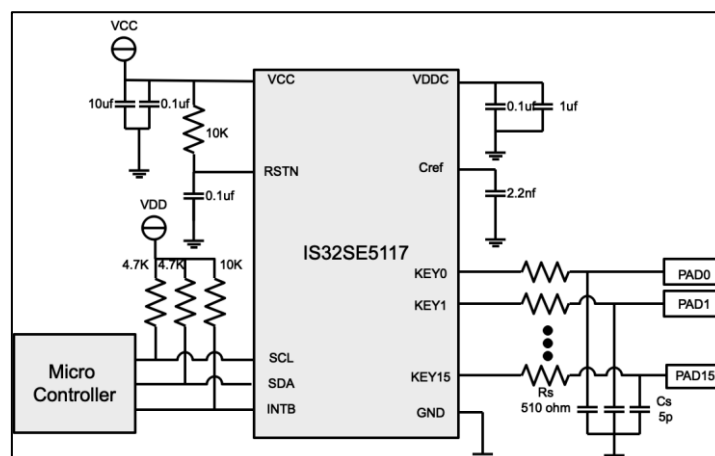


Figure 1 Typical Application Circuit (Wettable flank QFN-24)

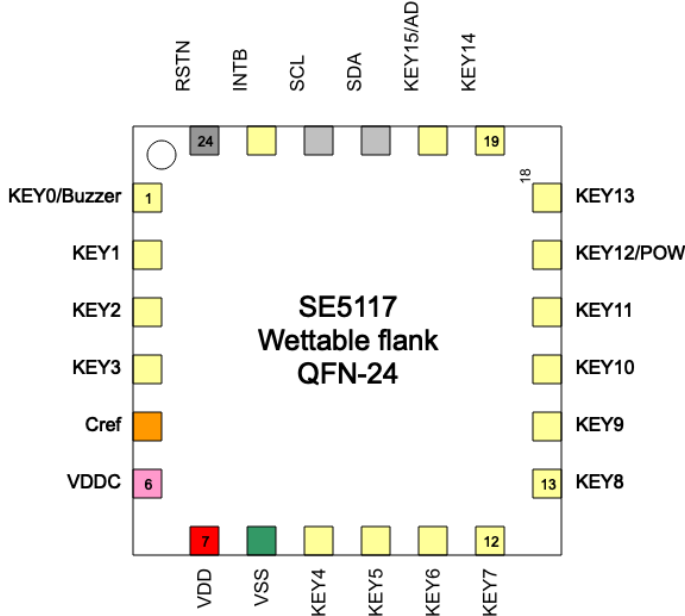
Note 1: The IC should be placed far away from the noise points in order to prevent the EMI.

Note 2: The R_s and C_s should place as close to IC as possible to reduce EMI.

Note 3: The AD pin can be configured as KEY15.

IS32SE5117

PIN CONFIGURATION

Package	Pin Configuration (Top View)
Wettable flank QFN-24	 SE5117 Wettable flank QFN-24

PIN DESCRIPTION

No.	Pin	Description
1	KEY0/Buzzer	Multiple functions. Can be configured as input sense channel 0, or buzzer output.
2 - 4	KEY1 – KEY3	Input sense channel 1 – 3
5	Cref	External Capacitor
6	VDDC	Typical decoupling capacitors of 0.1μF and 10μF should be connected between VDDC and GND.
7	VDD	Power supply
8	VSS	Ground
9 – 16	KEY4 – KEY11	Input sense channel 4 - 11
17	KEY12/POW	Multiple functions. Can be configured as input sense channel 12, or melody power control
18 – 19	KEY13 – KEY14	Input sense channel 13 - 14
20	AD/KEY15	Multiple functions. Can be configured as I2C address or input sense channel 15
21	SDA	I2C serial data
22	SCL	I2C serial clock
23	INTB	Interrupt output, active low
24	RSTN	Reset low active

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ORDERING INFORMATION

Automotive Range: -40°C to +125°C

Order Part No.	Package	QTY
IS32SE5117-QWLA3 -TR	Wettable flank QFN-24, Lead-free	2500/Reel

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- a.) the risk of injury or damage has been minimized;
- b.) the user assume all such risks; and
- c.) potential liability of Lumissil Microsystems is adequately protected under the circumstances

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ABSOLUTE MAXIMUM RATINGS

Supply voltage, V_{CC}	-0.3V ~ +6.0V
Voltage at any input pin	-0.3V ~ $V_{CC}+0.3V$
Maximum junction temperature, T_{JMAX}	+150°C
Storage temperature range, T_{STG}	-65°C ~ +150°C
Operating temperature range, $T_A=T_J$	-40°C ~ +125°C
Junction Package thermal resistance, junction to ambient (4 layer standard test PCB based on JESD 51-2A), θ_{JA} (Wettable flank QFN-24)	29.1°C/W
ESD (HBM)	±2kV
ESD (CDM)	±750V

Note 3: Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

$T_A = 25^\circ\text{C}$, $V_{CC} = 2.7V \sim 5.5V$, unless otherwise noted. Typical values are $T_A = 25^\circ\text{C}$, $V_{CC} = 3.6V$.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V_{CC}	Supply voltage		2.7		5.5	V
I_{CC}	Quiescent power supply current	$V_{CC} = 5.5V$		50		μA
I_{SD}	Shutdown current	$V_{CC} = 5.5V$		1		μA
ΔC_S	Minimum detectable capacitance	$C_S = 5pF$ (Note 4)		0.2		pF
Logic Electrical Characteristics						
V_{IL}	Logic “0” input voltage	$V_{CC} = 2.7V$			0.4	V
V_{IH}	Logic “1” input voltage	$V_{CC} = 5.5V$	1.4			V
I_{IL}	Logic “0” input current	$V_{INPUT} = 0V$ (Note 4)		5		nA
I_{IH}	Logic “1” input current	$V_{INPUT} = V_{CC}$ (Note 4)		5		nA

DIGITAL INPUT SWITCHING CHARACTERISTICS (Note 4)

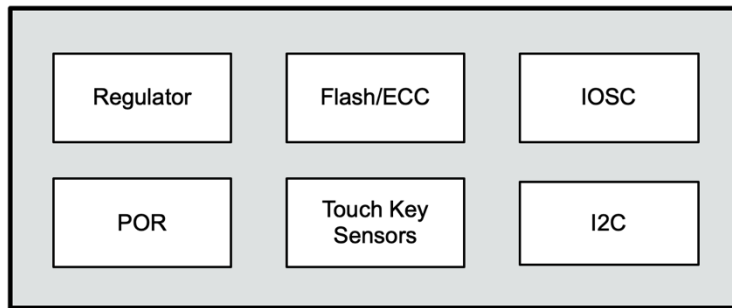
Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
f_{SCL}	Serial-Clock frequency				400	kHz
t_{BUF}	Bus free time between a STOP and a START condition		1.3			μs
$t_{HD, STA}$	Hold time (repeated) START condition		0.6			μs
$t_{SU, STA}$	Repeated START condition setup time		0.6			μs
$t_{SU, STO}$	STOP condition setup time		0.6			μs
$t_{HD, DAT}$	Data hold time				0.9	μs
$t_{SU, DAT}$	Data setup time		100			ns
t_{LOW}	SCL clock low period		1.3			μs
t_{HIGH}	SCL clock high period		0.7			μs
t_R	Rise time of both SDA and SCL signals, receiving	(Note 5)		$20+0.1C_b$	300	ns
t_F	Fall time of both SDA and SCL signals, receiving	(Note 5)		$20+0.1C_b$	300	ns

Note 4: Guaranteed by design.

Note 5: C_b = total capacitance of one bus line in pF. $I_{SINK} \leq 6mA$. t_R and t_F measured between $0.3 \times V_{CC}$ and $0.7 \times V_{CC}$.

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FUNCTIONAL BLOCK DIAGRAM



IS32SE5117

DETAILED DESCRIPTION

I2C INTERFACE

The IS32SE5117 uses a serial bus, which conforms to the I2C protocol, to control the chip's functions with two wires: SCL and SDA. IS31FL5117 has a 7-bit slave address (A7:A1), followed by the R/W bit, A0. Set A0 to "0" for a write command and set A0 to "1" for a read command. The value of bits A1 and A2 are determined by the connection of the AD pin, to GND, VDD, and Floating.

The complete slave address is:

Bit	A7:A3	A2:A1	A0
Value	01111	AD	1/0

AD floating, AD = 00;

AD connected to GND, AD = 01;

AD connected to VDD, AD = 10;

AD pin can also be configured as a Touch Key channel. When then AD pin is used for a Touch Key channel, A2: A1 = 00.

The SCL line is uni-directional. The SDA line is bi-directional (open-collector) with a pull-up resistor (typically 4.7kΩ). The maximum clock frequency specified by the I2C standard is 400kHz. In this discussion, the master is the microcontroller and the slave is the IS32SE5117.

The timing diagram for the I2C is shown in Figure 2. The SDA is latched in on the stable high level of the SCL. When there is no interface activity, the SDA line should be held high.

The "START" signal is generated by lowering the SDA signal while the SCL signal is high. The start signal will

alert all devices attached to the I2C bus to check the incoming address against their own chip address.

The 8-bit chip address is sent next, most significant bit first. Each address bit must be stable while the SCL level is high.

After the last bit of the chip address is sent, the master checks for the IS32SE5117's acknowledge. The master releases the SDA line high (through a pull-up resistor). Then the master sends an SCL pulse. If the IS32SE5117 has received the address correctly, then it holds the SDA line low during the SCL pulse. If the SDA line is not low, then the master should send a "STOP" signal (discussed later) and abort the transfer.

Following acknowledge of IS32SE5117, the register address byte is sent, most significant bit first. IS32SE5117 must generate another acknowledge indicating that the register address has been received.

Then 8-bit of data byte are sent next, most significant bit first. Each data bit should be valid while the SCL level is stable high. After the data byte is sent, the IS32SE5117 must generate another acknowledge to indicate that the data was received.

The "STOP" signal ends the transfer. To signal "STOP", the SDA signal goes high while the SCL signal is high.

READING PORT REGISTERS

To read the device data, the bus master must first send the IS32SE5117 address with the R/W bit set to "0", followed by the command byte, which determines which register is accessed. After a restart, the bus master must then send the IS32SE5117 address with the R/W bit set to "1". Data from the register defined by the command byte is then sent from the IS32SE5117 to the master (Figure 5).

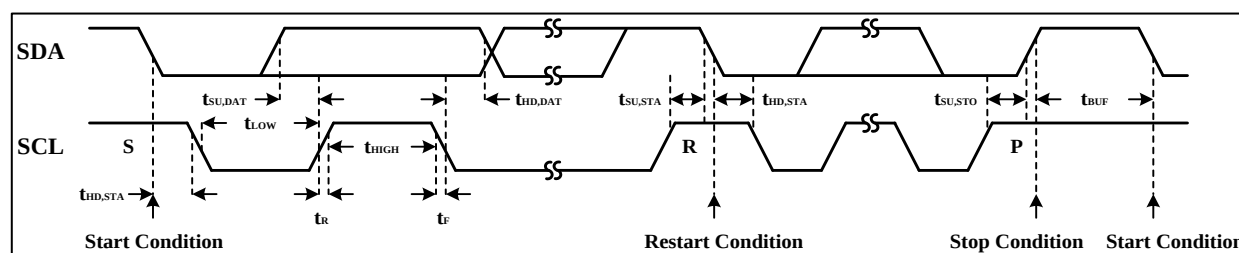


Figure 2 Interface Timing

IS32SE5117

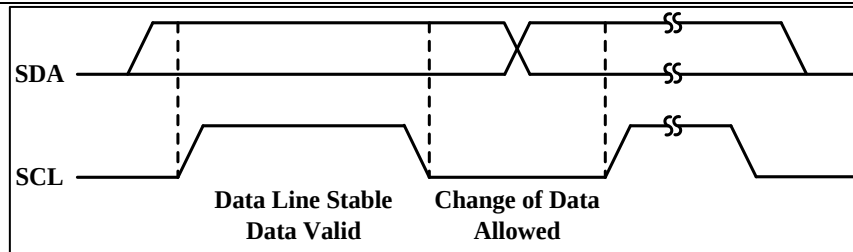


Figure 3 Bit Transfer

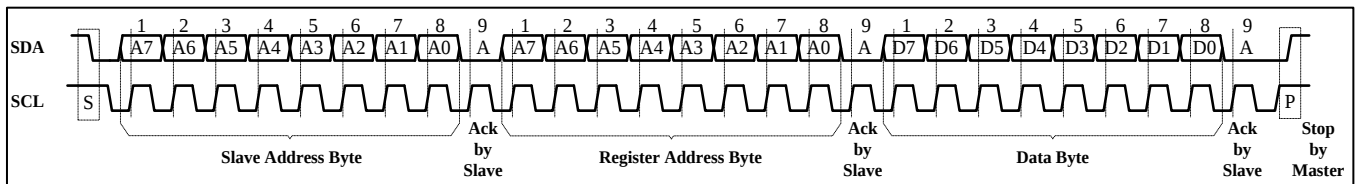


Figure 4 Writing to IS32SE5117

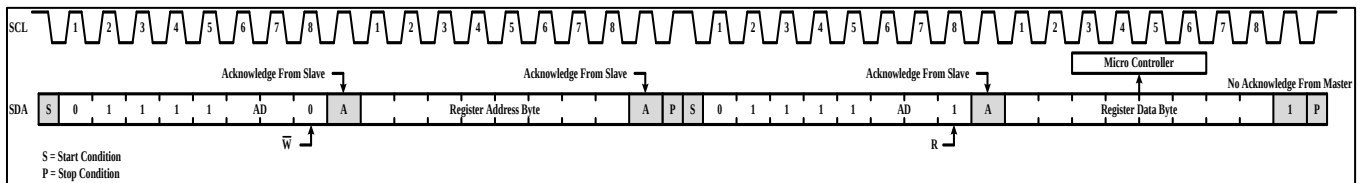


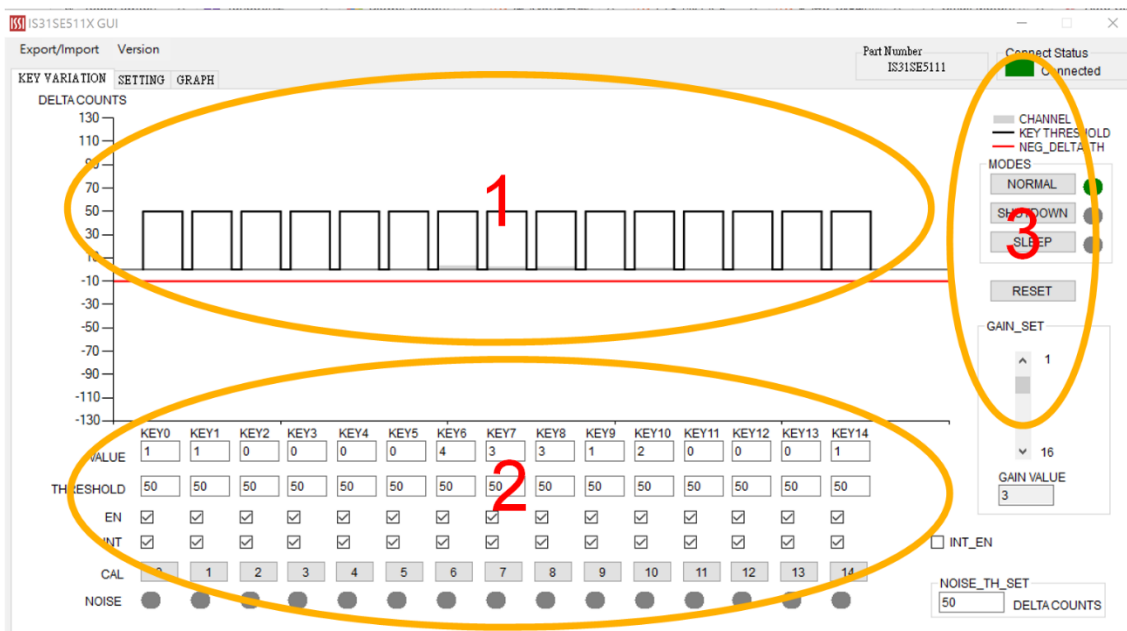
Figure 5 Reading from IS32SE5117

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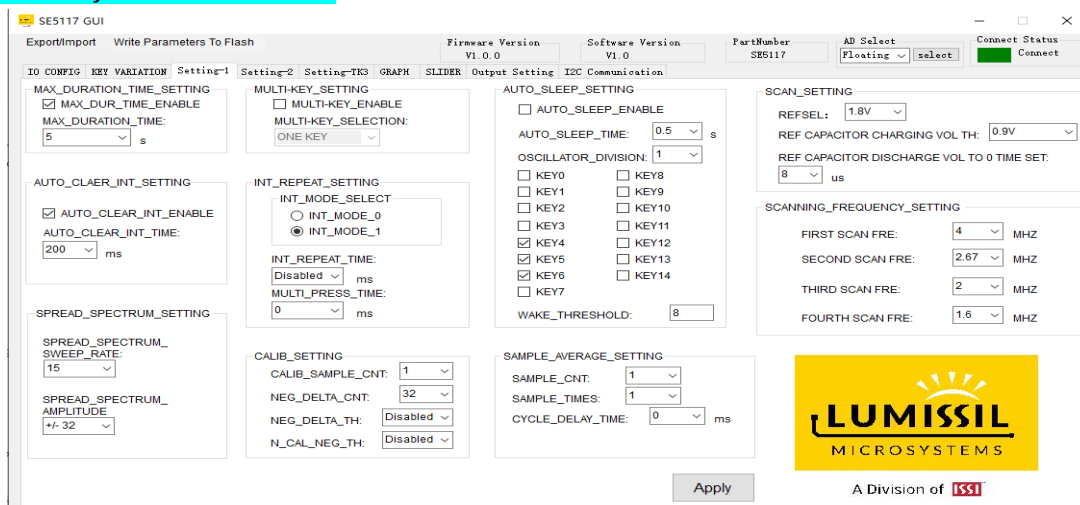
IS32SE5117 GUI

IS32SE5117 GUI is a windows-based Integrated Design Environment (IDE). User can use it to develop touch key applications without firmware coding. With the GUI user can design the touch key system easily. With the GUI you can:

1. Monitor the Key value
2. Set touch threshold and enable keys
3. Switch the operating modes
4. Setting-1, Tune System parameters
5. Setting-2, Tune System parameters
6. Setting-TK3, Tune TK3 System parameters
7. I/O Configuration
8. Outputs setting
9. Sliders setting



Setting-1, Tune System Parameters I



Setting-2, Tune System Parameters II

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Setting-TK3

I/O Configuration

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SE5117 GUI

Export/Import Write Parameters To Flash

Firmware Version V1.0.0 Software Version V1.0 PartNumber SE5117

AD Select Floating select Connect Status Disconnect

IO CONFIG KEY VARIATION Setting-1 Setting-2 Setting-TK3 GRAPH SLIDER Output Setting I2C Communication

	Touch Key	Slider1(Open-end)	Slider2(Open-end)	Shield	GPIO	GPIO(Initial Value)
Key0	☐	☐	☐	☐	☐	
Key1	☐	☐	☐	☐	☐	
Key2	☐	☐	☐	☐	☐	
Key3	☐	☐	☐	☐	☐	
Key4	☐	☐	☐	☐	☐	
Key5	☐	☐	☐	☐	☐	
Key6	☐	☐	☐	☐	☐	
Key7	☐	☐	☐	☐	☐	
Key8	☐	☐	☐	☐	☐	
Key9	☐	☐	☐	☐	☐	
Key10	☐	☐	☐	☐	☐	
Key11	☐	☐	☐	☐	☐	
Key12	☐	☐	☐	☐	☐	
Key13	☐	☐	☐	☐	☐	
Key14	☐	☐	☐	☐	☐	
Key15/AD	☐	☐	☐	☐	☐	

Apply

Output Setting

SE5117 GUI

Export/Import Write Parameters To Flash

Firmware Version V1.0.0 Software Version V1.0 PartNumber SE5117

AD Select Floating select Connect Status Connect

IO CONFIG KEY VARIATION Setting-1 Setting-2 Setting-TK3 GRAPH SLIDER Output Setting I2C Communication

Rule

When Key0 triggered, GPIO7 assumes toggle

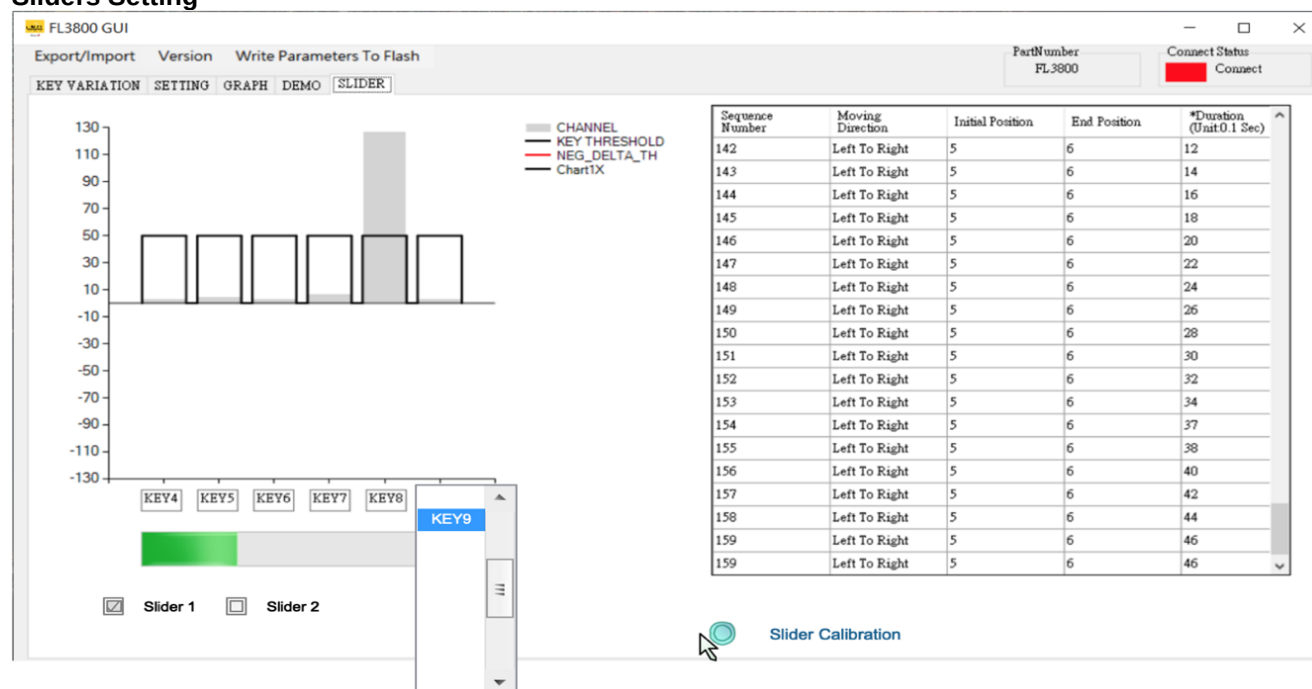
Add

Number	Rule Content	Delete
1	When Key0 triggered, GPIO7 assumes inverted.	Delete
2	When Key2 triggered, GPIO7 assumes inverted.	Delete
3	When Key3 triggered, GPIO7 assumes toggle.	Delete

Apply

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Sliders Setting



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Table 2 Register Function

Address	Name	Function	R/W	Default
00h	Main Control Register	Controls general power states and power dissipation	W	0000 0000
01h	INT Configuration Register	Interrupt configuration	R/W	0000 1000
02h	Key Status Register 1	Key0~Key7 status bits	R	0000 0000
03h	Key Status Register 2	Key8~Key14 status bits		
04h	Interrupt Enable Register 1	Key0~key7 Enables Interrupts associated with capacitive touch sensor inputs	R/W	0111 0000
05h	Interrupt Enable Register 2	Key8~key14 Enables Interrupts associated with capacitive touch sensor inputs		0000 0000
06h	Key Enable Register 1	Key0~key7 sets the channels enable		0111 0000
07h	Key Enable Register 2	Key8~key14 sets the channels enable		0011 1111
08h	Multiple Touch Key Configure Register	Multiple touch key function setting		0001 0000
09h	Auto-Clean Interrupt Register	Set auto-clean interrupt time and enable		
0Ah	Interrupt Repeat Time Register	Set repeat cycle for pressing key interrupt		0000 1111
0Bh	Auto-SLEEP Mode Register	Set auto enter SLEEP Mode time		
0Ch	Exit SLEEP Mode Register 1	Set press Key0~Key7 to exit SLEEP Mode		0111 0000
0Dh	Exit SLEEP Mode Register 2	Set press Key8~Key14 to exit SLEEP Mode		0000 0000
0Eh	Gain and Press Time Setting Register	Set gain and pressing trigger time		0001 1100
0Fh	Key Touch Sampling Configure Register	Set sampling times and cycle time		0001 0100
10h	Calibration Configure Register	Set auto-calibration cycle and negative value trigger setting		0011 0000
11h	Key Calibration Register 1	Key0~Key7 compel calibrate enable set		0000 0000
12h	Key Calibration Register 2	Key8~Key14 compel calibrate enable set		
13h	Noise Threshold Register	Set noise threshold value		0110 0100
14h	Noise Indication Register 1	Key0~Key7 noise indication		0000 0000
15h	Noise Indication Register 2	Key8~key14 noise indication		
16h	Signal/Baseline filter	Touch Key filters. Can adjuster IIR, Jitter		1001 1000
17h	Negative Threshold Register	Set negative threshold and compel calibration threshold		0000 1001
18h	Wake Up Threshold Register	Set wake up threshold		0000 0101
19h	Scan Voltage Register	Set scanning voltage		0111 0000
1Ah	CDTIME Configure Register 1	Set scanning frequency	R/W	0010 0001

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1Bh	CDTIME Configure Register 2	Set scanning frequency	R/W	0100 0011
1Ch	TKIII Control Register 1	Set repeat sequence, discard starting edges, inserts an inter-sequence idle time, and low frequency noise filter	R/W	0001 0011
1Dh	TKIII Control Register 2	Set pull-up current enable, internal charge capacitance.	R/W	0100 0000
1Eh	TKIII Control Register 3	Set operation mode, internal charge capacitance, and pull-up resistors	R/W	0111 0000
1Fh	TKIII Control Register 4	TKIII enable, clock stretching, set sleep	R/W	1010 0000
20h~2Fh	Variation Value Register	Keys value setting	R/W	0
30h~3Fh	Threshold Set Register	Keys threshold setting		0000 1111
40h,42h ... 5Dh,5Fh	Calibration Low Bit Register	Internal calibration low 8-bit for KEY0~KEY14	R	0000 0000
60h	GPIO enable Register 1	Sets the GPIO enable KEY0~KEY7	R/W	0000 1110
61h	GPIO enable Register 2	Sets the GPIO enable KEY8~KEY15	R/W	0000 0000
62h	GPIO Value Register 1	Sensing the GPIO values for KEY0 – KEY7	R/W	0000 1110
63h	GPIO Value Register 2	Sensing the GPIO values for KEY8 – KEY15	R/W	0000 0000
64h	Slider1 Enable Register 1	Sets Slider Enable KEY0~KEY7	R/W	0000 0000
65h	Slider1 Enable Register 2	Sets Slider Enable KEY8~KEY15	R/W	0011 1111
66h	Slider1 Status Register 1	Slider1 status reply1	R	0000 0000
67h	Slider1 Status Register 2	Slider1 status reply2	R	0000 0000
68h	Slider1 Status Register 3	Slider1 status register for slider bar or wheel	R/W	0000 0000
69h	Slider1 Key Position Register 1	Show the Key position of slider1	R/W	1000 1001
6Ah	Slider1 Key Position Register 2	Show the Key position of slider1	R/W	1010 1011
6Bh	Slider1 Key Position Register 3	Show the Key position of slider1	R/W	1100 1101

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6Ch	Slider2 Status Register 1	Slider2 status reply1	R	0000 0000
6Dh	Slider2 Status Register 2	Slider2 status reply2	R	0000 0000
6Eh	Slider2 Status Register 3	Slider2 status register for slider bar or wheel	R/W	0000 0000
6Fh	Slider2 Key Position Register 1	Show the Key position of slider2	R/W	0000 0000
70h	Slider2 Key Position Register 2	Show the Key position of slider2	R/W	0000 0000
71h	Slider2 Key Position Register 3	Show the Key position of slider2	R/W	0000 0000
72h	GPIO Toggle Enable 1	Enable GPIO Toggle mode for KEY0-KEY7	R/W	0001 0000
73h	GPIO Toggle Enable 2	Enable GPIO Toggle mode for KEY8-KEY15	R/W	0000 0000
74h	GPIO Mapping Register 1	GPIO rules mapping table 1 - 0	R/W	0000 0000
75h	GPIO Mapping Register 2	GPIO rules mapping table 3 – 2	R/W	0000 0000
76h	GPIO Mapping Register 3	GPIO rules mapping table 5 – 4	R/W	0001 0010
77h	GPIO Mapping Register 4	GPIO rules mapping table 7 – 6	R/W	0000 0011
78h	GPIO Mapping Register 5	GPIO rules mapping table 9 – 8	R/W	0000 0000
79h	GPIO Mapping Register 6	GPIO rules mapping table 11 – 10	R/W	0000 0000
7Ah	GPIO Mapping Register 7	GPIO rules mapping table 13 – 12	R/W	0000 0000
7Bh	GPIO Mapping Register 8	GPIO rules mapping table 15 - 14	R/W	0000 0000
7Ch	Set GPIO Shield function 1	Set GPIOs shield mode for KEY0-KEY7	R/W	0000 0000
7Dh	Set GPIO Shield function 2	Set GPIOs shield mode for KEY8-KEY15	R/W	0100 0000
7Eh	Noise Rejections	Noise filters	R/W	0101 1010
7Fh	Filter Setting Register	Filter setting	R/W	1000 1101
80h-81h	Sleep Mode Register 1 - 2	Sleep mode control related registers	R/W	0000 0000
83h-88h	Slider1 Calibration Registers	Slider1 calibration registers.	R/W	0010 1000
89h-8Eh	Slider2 Calibration Registers	Slider2 calibration registers.	R/W	0010 1000
8Fh	Spread Spectrum Registers	Spread spectrum register	R/W	1111 1100
90h	Version Control Register	Version Control	R/W	-
91h	Slider2 Enable Register 1	Slider Enable for KEY0-KEY7	R/W	0000 0000
92h	Slider2 Enable Register 2	Slider Enable for KEY8-KEY15	R/W	0000 0000

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93h	Fired Touch Key Register 1	Expressed useful touch keys in GPIO mapping table	R/W	0111 0000
94h	Fired Touch Key Register 2	Expressed useful touch keys in GPIO mapping table	R/W	0000 0000
95h-96h	Chip Version Control Register	Chip's Version Control	R	0000 0000
F0h	Buzzer Buffer Setting Register	Maximum tone buffer set	R	0000 1010
F0h	Buzzer Buffer Setting Register	Buzzer/Melody commands set	W	0000 0000
F8h-F9h	Buzzer Pin Selection Registers	I/O configuration for Buzzer/Melody Tone	R/W	0000 0100
FAh-FBh	Buzzer Power Pin Selection Registers	I/O configuration for Buzzer/Melody Power	R/W	0000 0000

00h Main Control Register (Write Only)

Bit	D7	D6	D5	D4	D3	D2:D0
Name	SR	RD	SDM	SP	SS	-
Default	0	0	0	0	0	000

SS Save SRAM Parameters

0	No function
1	Save parameters into Flash.

SR System Reset

0	Normal Mode
1	System Reset

SDM Shutdown Mode

0	Normal Mode
1	Shutdown Mode

RD Read Factory-set Value

0	No function
1	Save Factory-set value to Falsh

SP Sleep Mode

0	Normal Mode
1	SLEEP Mode

01h Interrupt Configuration Register

Bit	D7:D4	D3	D2	D1	D0
Name	-	MDE	INM	INE	-
Default	0000	1	0	0	0

MDEN Maximum Duration Time Enable

0	Disable
1	Enable

Maximum press function is used to prevent key pressing all the time by accident. When maximum press function is enabled, once key keep pressing at programmed time the key calibration value will be updated.

INM Interrupt Mode

0	Interrupt Mode 0(Touch key trigger once interrupt)
1	Interrupt Mode 1(Touch key trigger repeated interrupt)

INM bit sets interrupt time for once or multiple. Multiple interrupt is used for key pressing detection.

INE Interrupt Function Enable

0	Enable
1	Disable

02h Key Status Register 1 (Read only)

Bit	D7:D0
Name	KS[7:1]
Default	0000 0000

03h Key Status Register 2 (Read only)

Bit	D6:D0
Name	KS[14:8]
Default	000 0000

KSx Key0~Key14 Status

0	No action
1	Press or release keys

If the value of KSx is detected over programmed threshold, the corresponding bit will be set to "1".

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04h Interrupt Enable Register 1

Bit	D7:D0
Name	KINT[7:1]
Default	0111 0000

05h Interrupt Enable Register 2

Bit	D6:D0
Name	KINT[14:8]
Default	0000 0000

The Interrupt Enable Register determines whether a sensor pad touch or release (if enabled) causes the interrupt pin to be asserted.

KINTx Key Interrupt Enable

0	Disable
1	Enable

The default value for Interrupt Enable Registers is interrupt enable. Only set INE bit of Interrupt Configuration Register (01h) to "0", INTB pin will generate interrupt signal.

06h Key Enable Register 1

Bit	D7:D0
Name	KEN[7:1]
Default	0111 0000

07h Key Enable Register 2

Bit	D6:D0
Name	KEN[15:8]
Default	0011 1111

KENx Touch Key Enable Setting

0	Disable
1	Enable

08h Multiple Touch Key Configure Register

Bit	D7:D3	D2	D1:D0
Name	RTK[4:0]	MKEN	MTK
Default	00010	0	00

MKEN Multi- Key Enable

0	Disable
1	Enable

MTK Multi -Key Selection

01	Allow one key triggered at same time
10	Allow two keys triggered at same time
11	Allow three keys triggered at same time

RTK Repetition Times of Keys

Repetition-Times is used to enhance noise immunity. When a key was detected as a candidate to be triggered, 5117 will recheck other keys' status which is the count value of keys. If the status is safe, an internal counter will be increased by 1; otherwise, the internal counter will be decreased by 1. When the internal counter reaches RTK[4:0]+1, the candidate (key) was triggered.

09h Auto-Clear Interrupt Register

Bit	D7:D4	D3	D2:D0
Name	-	ACEN	ACT
Default	0000	0	000

ACEN Auto-Clear Interrupt Enable

0	Disable
1	Enable

ACT Auto-Clear Interrupt Time

000	10ms
001	20ms
010	30ms
011	40ms
100	50ms
101	100ms
110	150ms
111	200ms

When ACEN=0, the INTB will keep low until MCU read 02h and 03h registers. When ACEN=1, if MCU don't read 02h and 03h registers within programmed time (ACT=10ms~200ms), INTB pin will be release automatically.

0Ah Interrupt Repeat Time Register

Bit	D7:D4	D3:D0
Name	INTRT	MPT
Default	0000	1111

INTRT Interrupt Repeat Time

0000	Close
0001	50ms
0010	100ms

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0011	150ms
0100	200ms
0101	250ms
0110	300ms
0111	350ms
1000	400ms
1001	450ms
1010	500ms
1011	600ms
1100	700ms
1101	800ms
1110	900ms
1111	1s

MPT Multi-key Press Time

0000	Close
0001	50ms
0010	100ms
0011	150ms
0100	200ms
0101	250ms
0110	300ms
0111	350ms
1000	400ms
1001	450ms
1010	500ms
1011	600ms
1100	700ms
1101	800ms
1110	900ms
1111	1s

When set the INM as 1 and several keys are pressed, it will generate the second interrupt until M_PRESS_TIME after the first interrupt. Then wait for INT_RPT_TIME to trigger the third interrupt. After all of these if the keys are still pressing, wait for INT_RPT_TIME to trigger others interrupt until keys release.

0Bh Auto-SLEEP Mode Register

Bit	D7	D6:D4	D3:D0
Name	ASEN	OSCD	AST
Default	0	000	1111

ASEN Auto-SLEEP Enable

0	Disable
1	Enable

OSCD Auto-Sleep Oscillator Division

000	1
001	2
010	4
011	8
100	16
101	32
110	64
111	128

AST Auto-SLEEP Time

0000	0.5s
0001	1s
0010	1.5s
0011	2s
0100	2.5s
0101	3s
0110	3.5s
0111	4s
1000	4.5s
1001	5s
1010	6s
1011	7s
1100	8s
1101	9s
1110	10s

When ASEN=1 and no actions on touch key and I2C interface, the IC will enter into SLEEP Mode after programmed time (AST).

0Ch Exit SLEEP Mode Register 1

Bit	D7:D1
Name	ESMEN[7:1]
Default	0111 0000

0Dh Exit SLEEP Mode Register 2

Bit	D7:D0
Name	ESMEN[15:8]
Default	0000 0000

ESMENx Exit Sleep Mode Enable

0	Touch key can't trigger exiting SLEEP Mode
1	Touch key trigger exiting SLEEP Mode

When IC is in Normal Mode and ASEN=1, set ESMENx=1 will exit from SLEEP Mode by pressing the corresponding key.

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0Eh Gain and Press Time Setting Register

Bit	D7:D4	D3:D0
Name	GAIN	MDT
Default	0001	1100

GAIN Gain Control

0000	0.5X
0001	1X
0010	2X
0011	3X
0100	4X
0101	5X
0110	6X
0111	7X
1000	8X
1001	9X
1010	10X
1011	11X
1100	12X
1101	13X
1110	14X
1111	15X

The GAIN bits are used to set the gain factor. Internal count will count the final value and put it into KEYx_ΔCOUNT.

MDT Max Duration Time

0000	0.5s
0001	1s
0010	2s
0011	3s
0100	4s
0101	5s
0110	6s
0111	7s
1000	8s
1001	9s
1010	10s
1011	11s
1100	12s
1101	13s
1110	14s
1111	15s

MPT bits set the pressing time. When key pressed continue over the programmed time (MDT), system

will force to calibrate the pressed key. Set MDEN to "1" will enable this function.

0Fh Key Touch Sampling Configure Register

Bit	D7:D4	D3:D2	D1:D0
Name	SC	RT	CDS
Default	0001	01	00

SC is used to set sampling average times for each channel.

Higher SC value will increase stability and anti-interference ability, but decrease reaction speed.

0000	1,
0001	2
0010	3
0011	4
0100	5
0101	6
0110	7
0111	8
1000	9
1001	10
1010	11
1011	12
1100	13
1101	14
1110	15
1111	16

RT Repeat Times (Single Channel)

00	1
01	2
10	4
11	8

RT is used to set how many repeat times in a channel.

CDS Cycle Delay Time

00	0ms
01	10ms
10	20ms
11	40ms

Sampling 16 channels is for one cycle.

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10h Calibration Configure Register

Bit	D7	D6:D4	D3:D2	D1:D0
Name	-	CSC	BLP	NDC
Default	0	011	00	00

CSC Calibrate Sample Count

000	1
001	2
010	4
011	8
100	16
101	32
110	64
111	128

If there is no action on keys, environmental capacitance will be calibrated after CSC times.

BLP Baseline Update Period

00	2 sec
01	4 sec
10	8 sec
11	16 sec

NDC Negative Delta Count

00	16
01	32
10	64
11	128

If channel detects the value over negative threshold (NDTH) for NDC times, it will be calibrated forcibly.

11h Individual Force Calibration Register 1

Bit	D7:D1
Name	FCK7:FCK1
Default	0000 0000

12h Individual Force Calibration Register 2

Bit	D6:D0
Name	FCK14:FCK8
Default	000 0000

FCKx Individual Force Calibrate Key

0	Close
1	Enable

When enable FCKx, the corresponding bit will be set to "1".

13h Noise Threshold Register

Bit	D7:D0
Name	NTH
Default	0110 0100

The noise threshold is from 0~127. It is invalid if NTH>127.

If difference value between samplings is over the programmed threshold, the corresponding noise bit will be set to "1".

14h Noise Indication Register 1

Bit	D7:D1
Name	NK7:NK1
Default	0000 0000

15h Noise Indication Register 2

Bit	D6:D0
Name	NK15:NK8
Default	0000 0000

NKx Noise Indication

0	No noise
1	Noise

16h TK Filter

Bit	D3	D2	D1:D0
Name	BLIIR	-	TKMA
Default	1	-	00

Bit	D7	D6	D5	D4
Name	SIGIIR	SIGM	SIGJ	SCTS
Default	1	0	0	1

TKMA TK Moving Average

00	32 average
01	64 average
10	128 average
11	256 average

Hardware baseline slow moving average setting

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BLIIR TK IIR Filter for Baseline

0	Disable BLIIR
1	Enable BLIIR

SCTS Scanning Times

0	Scan one time
1	Scan four times

SIGJ Signal Jitter Filter

0	Disable jitter filter
1	Enable jitter filter

SIGM Signal Median Filter

0	Disable SIGM filter
1	Enable SIGM filter

SIGIIR Signal IIR filter

0	Disable IIR filter
1	Enable IIR filter

17h Negative Threshold Register

Bit	D3:D0	D3:D0
Name	NCTH	NDTH
Default	0000	1001

NCTH Negative Calibrate Threshold Setting.

0000	Disable
0001	-10
0010	-20
0011	-30
0100	-40
0101	-50
0110	-60
0111	-70
1000	-80
1001	-90
1010	-100
1011	-110
1100	-120
1101	NA
1110	NA
1111	NA

When negative value is over the programmed threshold (NCTH), the channel will be calibrated forcibly.

NDTH Negative Delta Threshold Setting

0000	Disable
0001	-1
0010	-2
0011	-3
0100	-4
0101	-5
0110	-6
0111	-7
1000	-8
1001	-9
1010	-10
1011	-11
1100	-12
1101	-13
1110	-14
1111	-15

When negative value is over the programmed threshold (NCTH), the channel will be calibrated forcibly.

If negative value is detected over threshold for NDTH times continually, the channel will be calibrated forcibly.

18h Wake Up Threshold Register

Bit	D7	D6:D0
Name	-	WTH[6:0]
Default	0	000 0101

Wake up threshold range from 0 to 127

19h Scan Voltage Register

Bit	D2:D0		
Name	CCNT		
Default	000		
Bit	D7	D6:D4	D3
Name	VTH	ZERO_Time [2:0]	REFSEL
Default	0	111	0

CCNT Cycle Count of Each Conversion Sequence

000	1024
001	2048
010	4096
011	8192
100	12288
101	16384
110	32768

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111 65536

VTH Scan Voltage

If REFSEL = 0

0 Cref charges to 0.9V
1 Cref charges to 1.35V

If REFSEL = 1

0 Cref charges to VDD*0.5
1 Cref charges to VDD*0.75

ZERO_Time [2:0] Discharge time of Cref

000 8 us
001 16 us
010 24 us
011 32 us
100 40 us
101 48 us
110 56 us
111 64 us

REFSEL Cref charges source selection

0 The Cref charging source is VDDC.
1 The Cref charging source is VDD.

1Ah Scanning Frequency Set

Bit	D7:D4	D3:D0
Name	Second scan frequency (SSF)	First scan frequency (FSF)
Default	0010	0001

Scanning frequency First scan frequency

0000 8 MHz
0001 4 MHz
0010 2.67 MHz
0011 2 MHz
0100 1.6 MHz
0101 1.33 MHz
0110 1.14 MHz
0111 1 MHz
1000 0.89 MHz
1001 0.8 MHz
1010 0.73 MHz
1011 0.67 MHz
1100 0.62 MHz
1101 0.57 MHz
1110 0.53 MHz
1111 0.5M HZ

Scanning frequency Second scan frequency

0000 8 MHz

0001 4 MHz
0010 2.67 MHz
0011 2 MHz
0100 1.6 MHz
0101 1.33 MHz
0110 1.14 MHz
0111 1 MHz
1000 0.89 MHz
1001 0.8 MHz
1010 0.73 MHz
1011 0.67 MHz
1100 0.62 MHz
1101 0.57 MHz
1110 0.53 MHz
1111 0.5M HZ

1Bh Scanning Frequency Set

Bit	D7:D4	D3:D0
Name	Fourth scan frequency (OSF)	Third scan frequency (TSF)
Default	0100	0011

Scanning frequency Third scan frequency

0000 8 MHz
0001 4 MHz
0010 2.67 MHz
0011 2 MHz
0100 1.6 MHz
0101 1.33 MHz
0110 1.14 MHz
0111 1 MHz
1000 0.89 MHz
1001 0.8 MHz
1010 0.73 MHz
1011 0.67 MHz
1100 0.62 MHz
1101 0.57 MHz
1110 0.53 MHz
1111 0.5M HZ

Scanning frequency Fourth scan frequency

0000 8 MHz
0001 4 MHz
0010 2.67 MHz
0011 2 MHz
0100 1.6 MHz
0101 1.33 MHz
0110 1.14 MHz
0111 1 MHz
1000 0.89 MHz

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1001	0.8 MHZ
1010	0.73 MHZ
1011	0.67 MHZ
1100	0.62 MHZ
1101	0.57 MHZ
1110	0.53 MHZ
1111	0.5M HZ

000	10pF
001	20pF
010	30pF
011	40pF
100	50pF
101	60pF
110	70pF
111	80pF

1Ch TKIII Control1

Bit	D7:D6	D5:D4	D3:D2	D1:D0
Name	RPT[1:0]	INI[1:0]	ASTDL	LFNF
Default	00	01	00	11

LFNF Low Frequency Noise Filter Setting

Low Frequency Noise Filter Setting

00 disable LFNE

Noise injection longer than LFNF[1-0]*8 time is ignored.

ASTDLY Auto Mode Start Delay

ASTDLY[1-0] inserts an inter-sequence idle time of (ASTDLY[1-0]+1) * 256 TKCLK at each sequence start. This delay allows the stabilization time from normal mode to sleep mode.

INI Initial Setting Delay

INI[1-0] defines the number of TKCLK period for initial settling of CREF. The delay is (INI[1-0] + 1) * 4 * TKCLK.

RPT Repeat Sequence Count

00	No repeat
01	Repeat 4 times
10	Repeat 8 times
11	Repeat 16 times

1Dh TKIII Control2

Bit	D7	D6:D4	D3:D0
Name	PUREN	CCHG	PU[3:0]
Default	0	100	0000

PUREN Pull up DC Current Enable

0	disable pull up DC current
1	enable pull up DC current

CCHG Internal Reference Capacitance Select

PU Pull up DC Current

1000	Enable 8uA current source.
0100	Enable 4uA current source.
0010	Enable 2uA current source.
0001	Enable 1uA current source.

1Eh TKIII Control3

Bit	D7	D6:D4	D3:D0
Name	PUREN	SCCHG	SPU[3:0]
Default	0	111	0000

PUREN Pull up DC Current Enable in Sleep Mode

0	disable pull up DC current
1	enable pull up DC current

SCCHG Internal Reference Capacitance Select in Sleep Mode

000	10pF
001	20pF
010	30pF
011	40pF
100	50pF
101	60pF
110	70pF
111	80pF

SPU Pull up DC Current in Sleep Mode

1000	Enable 8uA current source.
0100	Enable 4uA current source.
0010	Enable 2uA current source.
0001	Enable 1uA current source.

1Fh TKIII Control 4

Bit	D3	D2:D1	D0
Name	-	FOT	TK3AS
Default	-	00	0

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Bit	D7	D6	D5	D4
Name	TK3E	CLKS	PRS	TK3S
Default	1	0	1	0

TK3AS Enable TK3 Auto Sleep Mode

0	disable TK3 Auto Sleep Mode
1	enable TK3 Auto Sleep Mode

FOT Focus Times

How many consecutive

00	2 times
01	3 times
10	4 times
11	5 times

TK3S TK3 Test Bit

0	No function
1	Read baseline count and save it into 80h/81h

PRS Pseudo Random Sequence (only for TKIII)

0	disable PRS
1	enable PRS

CLKS Clock Stretching (For I2C)

0	disable stretching
1	enable stretching

TK3E TK3 Enable

0	enable TK2
1	enable TK3

20h~2Fh KEY0~KEY15 Variation Value Register

Bit	D7	D6:D0
Name	SIGN	KEYx_ΔCOUNT
Default	0	000 0000

SIGB Sign bit

0	Positive
1	Negative

KEYx_ΔCOUNT Key Value Count

30h~3Fh KEY0~KEY15 Threshold Set Register

Bit	D7	D6:D0
Name		KEYx_TH
Default	0	000 1111

KEYx_TH Key Threshold 0~127

40h, 42h ... 5Ch, 5Eh KEY0~KEY15 Calibration Low Byte Register (Read Only)

Bit	D7:D0
Name	KEY0_CAL_L
Default	0000 0000

41h, 43h ... 5Dh, 5Fh KEY0~KEY15 Calibration High Byte Register (Read only)

Bit	D7:D0
Name	KEY0_CAL_H
Default	0000 0000

60h GPIO Enable Register 1

Bit	D7:D0
Name	GPE [7:0]
Default	0000 1110

61h GPIO Enable Register 2

Bit	D7:D0
Name	GPE [15:8]
Default	0000 0000

GPE GPIO Enable

0	disable GPIO function
1	enable GPIO function

62h GPIO Value Register 1

Bit	D7:D1
Name	GPV [7:0]
Default	0000 1110

63h GPIO Value Register 2

Bit	D7:D0
Name	GPV [15:8]
Default	0000 0000

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GPV GPIO Value

Define GPIO values

- 0 GPIO=0, when **OD=1** and **GPE** is enabled.
1 GPIO=1, when **OD=1** and **GPE** is enabled.

64h Slider1 Enable Register 1

Bit	D7:D1
Name	SL1EN [7:0]
Default	0000 0000

65h Slider1 Enable Register 2

Bit	D7:D0
Name	SL1EN [15:8]
Default	0011 1111

SL1ENx Enable Slider Mode

- 0 Disable Touch Key channel enter Slider Mode.
1 Enable Touch Key channel enter Slider Mode; a channel cannot be a Touch Key sensor or GPIO while it's set to be a slider.
A slider is composed of six Touch Key sensors. User can use GPIO to select them.

66h Slider1 Status Register1

Bit	D7	D6:D0
Name	ACT	INIP
Default	0	0000000

- ACT** Slider is active
0 disable slider
1 enable slider
INIP Initial position

67h Slider1 Status Register2

Bit	D7	D6:D0
Name	DIR	ENDP
Default	0	0000000

- DIR** Direction of Slide1
0 Rotated to left
1 Rotated to right

ENDP end position of the slider

68h Slider1 Status Register3

Bit	D7	D6:D0
Name	STA	DUR
Default	0	0000000

- STA** Status of Slider1
0 it is a wheel
1 it is a slider

DUR Duration
measure the duration between initial position to end position. The unit is with 0.1s based.

69h Slider1 Map Register 1

Bit	D7:D4	D3:D0
Name	S1K1[3:0]	S1K2[3:0]
Default	1000	1001

6Ah Slider1 Map Register 2

Bit	D7:D4	D3:D0
Name	S1K3[3:0]	S1K4[3:0]
Default	1010	1011

6Bh Slider1 Map Register 3

Bit	D7:D4	D3:D0
Name	S1K5[3:0]	S1K6[3:0]
Default	1100	1101

S1Kx Slider1 Keyx Map table
Slider1 KEYx is mapped to Touch Key S1Kx[3:0]

6Ch Slider2 Status Register1

Bit	D7	D6:D0
Name	ACT	INIP
Default	0	0000000

- ACT** Slider2 is active
0 disable slider
1 enable slider

INIP Initial position

6Dh Slider2 Status Register2

Bit	D7	D6:D0
Name	DIR	ENDP
Default	0	0000000

- DIR** Direction of Slide2
0 Rotated to left
1 Rotated to right

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ENDP end position of the slider

6Eh Slider2 Status Register3

Bit	D7	D6:D0
Name	STA	DUR
Default	0	0000000

STA Status of Slider2

0 it is a wheel

1 it is a slider

DUR Duration

measure the duration between initial position to end position. The unit is with 0.1s based.

6Fh Slider2 Map Register 1

Bit	D7:D4	D3:D0
Name	S2K1[3:0]	S2K2[3:0]
Default	0000	0000

70h Slider2 Map Register 2

Bit	D7:D4	D3:D0
Name	S2K3[3:0]	S2K4[3:0]
Default	0000	0000

71h Slider2 Map Register 3

Bit	D7:D4	D3:D0
Name	S2K5[3:0]	S2K4[3:0]
Default	0000	0000

S2Kx Slider2 Keyx Map table

Slider2 KEYx is mapped to Touch Key S2Kx[3:0]

72h GPIO Toggle Enable Register 1

Bit	D7:D0
Name	TOEN [7:0]
Default	0001 0000

73h GPIO Toggle Enable Register 2

Bit	D7:D0
Name	TOEN [15:8]
Default	0000 0000

TOENx Enable GPIO Toggle Mode

0 Disable Touch Key channel enter GPIO Toggle Mode.

1 Enable Touch Key channel enter GPIO Toggle Mode.

74h GPIO Map Register 1

Bit	D7:D4	D3:D0
Name	GM1[3:0]	GM0[3:0]
Default	0000	0000

75h GPIO Map Register 2

Bit	D7:D4	D3:D0
Name	GM3[3:0]	GM2[3:0]
Default	0000	0000

76h GPIO Map Register 3

Bit	D7:D4	D3:D0
Name	GM5[3:0]	GM4[3:0]
Default	0001	0010

77h GPIO Map Register 4

Bit	D7:D4	D3:D0
Name	GM7[3:0]	GM6[3:0]
Default	0000	0011

78h GPIO Map Register 5

Bit	D7:D4	D3:D0
Name	GM9[3:0]	GM8[3:0]
Default	0000	0000

79h GPIO Map Register 6

Bit	D7:D4	D3:D0
Name	GM11[3:0]	GM10[3:0]
Default	0000	0000

7Ah GPIO Map Register 7

Bit	D7:D4	D3:D0
Name	GM13[3:0]	GM12[3:0]
Default	0000	0000

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7Bh GPIO Map Register 8

Bit	D7:D4	D3:D0
Name	GM15[3:0]	GM14[3:0]
Default	0000	0000

GMx [3:0] Map touch key channel to GPIOx
The variable x is used to express which touch key channel. GMx [3:0] shows which GPIO map to the touch key channel.

7Ch Shield Setting Register 1

Bit	D7:D1
Name	SHDE [7:0]
Default	0000 0000

7Dh Shield Setting Register 2

Bit	D6:D0
Name	SHDE [15:8]
Default	0100 0000

SHDE Shield Enable
0 disable shield driver
1 enable shield driver

7Eh Noise Rejections Setting Register

Bit	D3	D2:D0
Name	NIBF	IBP[2:0]
Default	1	010

Bit	D7:D6	D5:D4
Name	ISP[1:0]	NIBP[1:0]
Default	01	01

IBP IIR Baseline Parameters.

000	1
001	1/2
010	1/4
011	1/8
100	1/16
101	1/32
110	1/64
111	1/128

NIBF Negative IIR Baseline Flag
0 disable Negative IIR
1 detect negative sensing values

NIBP Negative IIR Parameters

00	1
01	2
10	-1
11	-2

ISP IIR Sensing Parameters

00	1
01	1/2
10	1/4
11	1/8

7Fh Filter Parameter Register

Bit	D4:D3	D2	D1:D0
Name	JD	NA	SD
Default	01	1	01

Bit	D7:D6	D5
Name	HYP	SORT
Default	10	0

SD Sort Delta Parameters

00	1
01	0.8
10	0.6
11	0.4

NA Normalization After Sort

0 No function
1 Execution of normalization after sort instruction

JD Jitter Deltat

00	1
01	2
10	3
11	4

SORT Anti-threshold Sorting

0 disable sorting
1 enable sorting

HYP Hysteresis Parameters

00	0.9
01	0.8
10	0.7
11	0.6

80h Sleep Mode Count Register 1

Bit	D7:D1
Name	SLPC [7:0]
Default	0000 0000

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81h Sleep Mode Count Register 2

Bit	D67:D0
Name	SLPC [15:8]
Default	0000 0000

SLPC Sleep Mode Count

Read only, reference value

83h – 88h Slider1 Calibration Register 1 - 6

Bit	D7:D1
Name	S1CRKx[7:0]
Default	0010 1000

S1CRKx These registers are used for slider1 calibration. The slider1 is composed of six touch keys. The range of x is from 1 to 6 which means as key1 to key6.

89h – 8Eh Slider2 Calibration Register 3

Bit	D7:D1
Name	S2CRKx [7:0]
Default	0010 1000

S2CRKx These registers are used for slider2 calibration. The slider2 is composed of six touch keys. The range of x is from 1 to 6 which means as key1 to key6.

8Fh Spread Spectrum Register

Bit	D7:D1
Name	SSR[3:0] SSA[1:0] -
Default	1111 11 -

SSS Spread Spectrum Setting Register
Spread spectrum is a technique by which electromagnetic energy produced over a particular bandwidth is spread in the frequency domain. Two parameters are listed as follows:

SSR [3:0] defines the spread spectrum sweep rate. If the SSR[3:0]=0, then spread spectrum is disabled

SSA[1:0] defines the amplitude of spread spectrum frequency change. The frequency is changed by adding SSA[1:0] range to the actual internal OSC control register.

00 +/- 32

01 +/- 16

10 +/- 8

11 +/- 4

90h Version Control Register 6

Bit	D7:D0
Name	VCR1 [1:0] VCR2[2:0] VCR3[2:0]
Default	01 000 000

VCR Version Control Reister

SSMR [7:0] is used to do slider calibration. User can enable the calibration via GUI.

91h Slider2 Enable Register 1

Bit	D7:D1
Name	SL2EN [7:0]
Default	0000 0000

92h Slider2 Enable Register 2

Bit	D7:D0
Name	SL2EN [15:8]
Default	0000 0000

SL2ENx Enable Slider Mode

0 Disable Touch Key channel enter Slider Mode.

1 Enable Touch Key channel enter Slider Mode; a channel cannot be a Touch Key sensor or GPIO while it's set to be a slider.

A slider is composed of six Touch Key sensors. User can use GPIO to select them.

93h Fired Touch Key Register 1

Bit	D7:D1
Name	FTK [7:0]
Default	0111 0000

94h Fired Touch Key Register 2

Bit	D7:D0
Name	FTK [15:8]
Default	0000 0000

FTK Fired Touch Key indicator

0 Disable. Touch Key channel didn't be used in the GPIO mapping table

1 Enable, the Touch Key channel be used in the GPIO mapping table.

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95h Chip Version Control Register 1

Bit	D7:D1
Name	CVR1 [7:0]
Default	0000 0000

96h Chip Version Control Register 2

Bit	D7:D0
Name	CVR2 [15:8]
Default	0000 0000

CVR Chip Version Register

These 2 bytes contain chip revision. The first byte indicates mask set version. The 2nd byte indicates minor revision.

A0h – AFh tables are not for users. They are internal operating registers.

A0h, A2h ... ACh, AEh KEY0~KEY15

Sensing Low Byte Register (Read Only)

Bit	D7:D0
Name	KEY0_CAL_L
Default	0000 0000

A1h, A3h ... ADh, AFh KEY0~KEY15

Sensing High Byte Register (Read only)

Bit	D7:D0
Name	KEY0_CAL_H
Default	0000 0000

Sensing Registers are the output of software's IIR filters

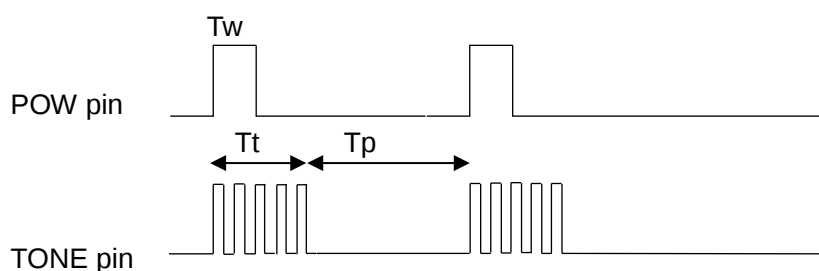
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TYPICAL APPLICATION INFORMATION

F0h Buzzer/Melody Register (W)

Bit	N*(4 byte)
Name	BMRR
Default	-

1st byte	2nd byte	3rd byte	forth byte
Scale ID	Tt	Tw	Tp



Tt, Tw and Tp range from 0 to 255 @ 4ms time unit

A Tone play duration is defined as Tt + Tp

The support scale from 3A to 8G#

Frequencies for equal-tempered scale, A4 = 440 Hz "Middle C" is C4												
	3	freq	divisor	freq error	4	freq	divisor	freq error	5	freq	divisor	freq error
C					3	261.6	1911	0.01%	15	523.3	956	-0.05%
C#					4	277.2	1804	-0.01%	16	554.4	902	-0.01%
D					5	293.7	1703	-0.02%	17	587.3	851	0.04%
D#					6	311.1	1607	0.00%	18	622.3	804	-0.06%
E					7	329.6	1517	-0.01%	19	659.3	758	0.06%
F					8	349.2	1432	-0.02%	20	698.5	716	-0.02%
F#					9	370.0	1351	0.03%	21	740.0	676	-0.05%
G					10	392.0	1276	-0.04%	22	784.0	638	-0.04%
G#					11	415.3	1204	-0.01%	23	830.6	602	-0.01%
A	0	220.0	2273	-0.01%	12	440.0	1136	0.03%	24	880.0	568	0.03%
A#	1	233.1	2145	0.01%	13	466.2	1073	-0.04%	25	932.3	536	0.05%
B	2	246.9	2025	-0.01%	14	493.9	1012	0.04%	26	987.8	506	0.04%

	6	freq	divisor	freq error	7	freq	divisor	freq error	8	freq	divisor	freq error
C	27	1046.5	478	-0.05%	39	2093.0	239	-0.05%	51	4186.0	119	0.37%
C#	28	1108.7	451	-0.01%	40	2217.5	225	0.21%	52	4434.9	113	-0.23%

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D	29	1174.7	426	-0.08%	41	2349.3	213	-0.08%	53	4698.6	106	0.39%
D#	30	1244.5	402	-0.06%	42	2489.0	201	-0.06%	54	4978.0	100	0.44%
E	31	1318.5	379	0.06%	43	2637.0	190	-0.21%	55	5274.0	95	-0.21%
F	32	1396.9	358	-0.02%	44	2793.8	179	-0.02%	56	5587.7	89	0.54%
F#	33	1480.0	338	-0.05%	45	2960.0	169	-0.05%	57	5919.9	84	0.55%
G	34	1568.0	319	-0.04%	46	3136.0	159	0.28%	58	6271.9	80	-0.35%
G#	35	1661.2	301	-0.01%	47	3322.4	150	0.33%	59	6644.9	75	0.33%
A	36	1760.0	284	0.03%	48	3520.0	142	0.03%				
A#	37	1864.7	268	0.05%	49	3729.3	134	0.05%				
B	38	1975.5	253	0.04%	50	3951.1	127	-0.36%				

Scale ID(Sid): 0 is 3A, 1 is 3A#, 2 is 3B

F0h Buzzer/Melody Register (W)

Bit	D7:D0 = 0xFF
Name	BMRR
Default	-

Clear Melody buffer and stop play

F0h Buzzer/Melody Register (R)

Bit	D7:D0
Name	BMRR
Default	-

BMRR Buzzer/Melody Register Read. It shows the available tone buffer size. SE5118 has 10 note buffer built-in.

I2C command format (each node is composed of 4 byte data, the incomplete note will be ignored, and the incoming note data will be ignored if the FIFO is full)

0x78, 0xF0, (Sid, Tt, Tw, Tp), (Sid, Tt, Tw, Tp),

0x78, 0xF0, 0xFF stop the melody play and clear the FIFO

0x78, 0xF0 set the register number to 0xF0

0x79 read FIFO remain length

A reference schematic and tone waveform are introduced as follows:

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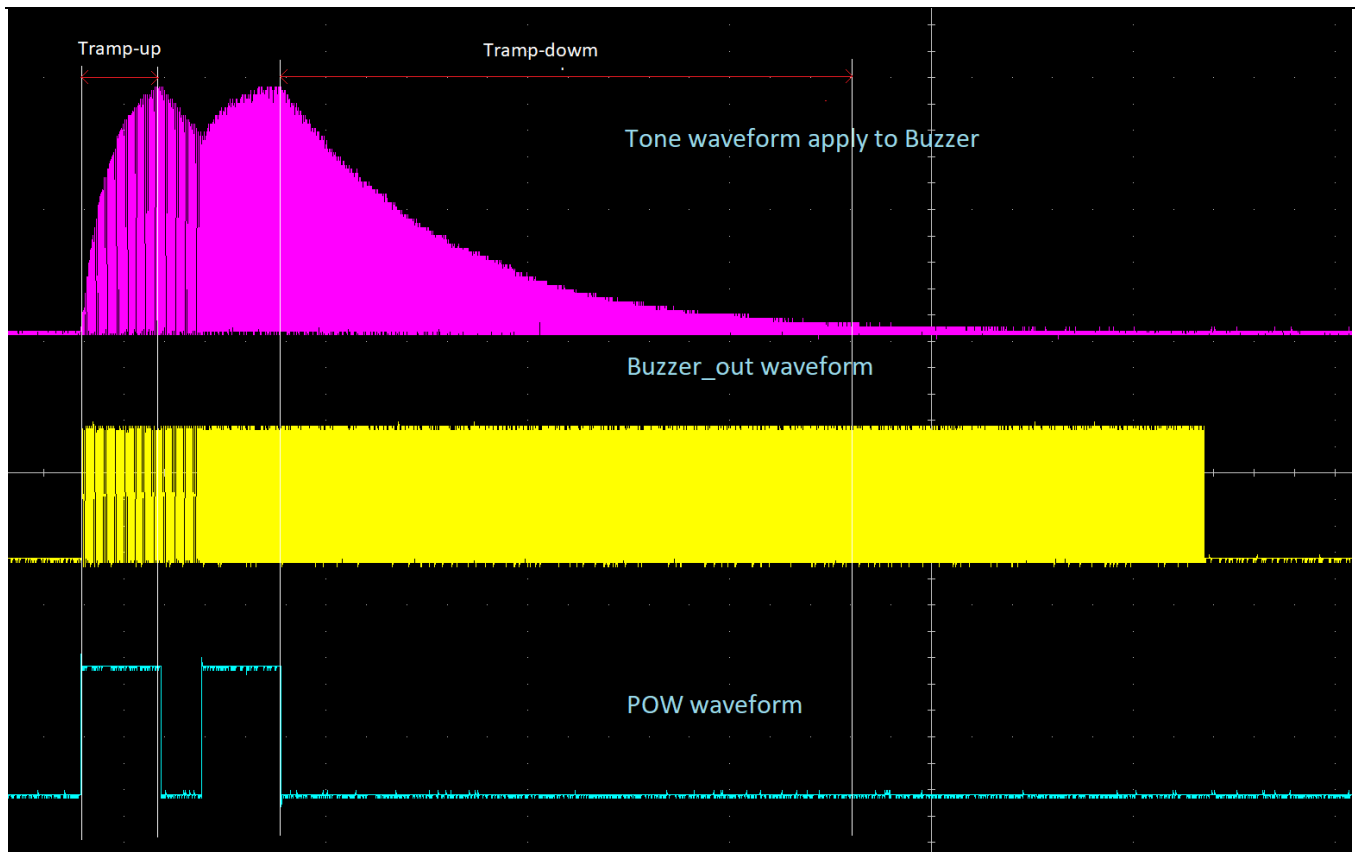


Figure 6 Buzzer/ Melody waveform example

Note:

$T_{\text{ramp-up}}$: 100R decides the signal ramp up rate.

$T_{\text{ramp-down}}$: The signal ramp down due to POW is low and 47uF capacitor decide the ramp down rate.\

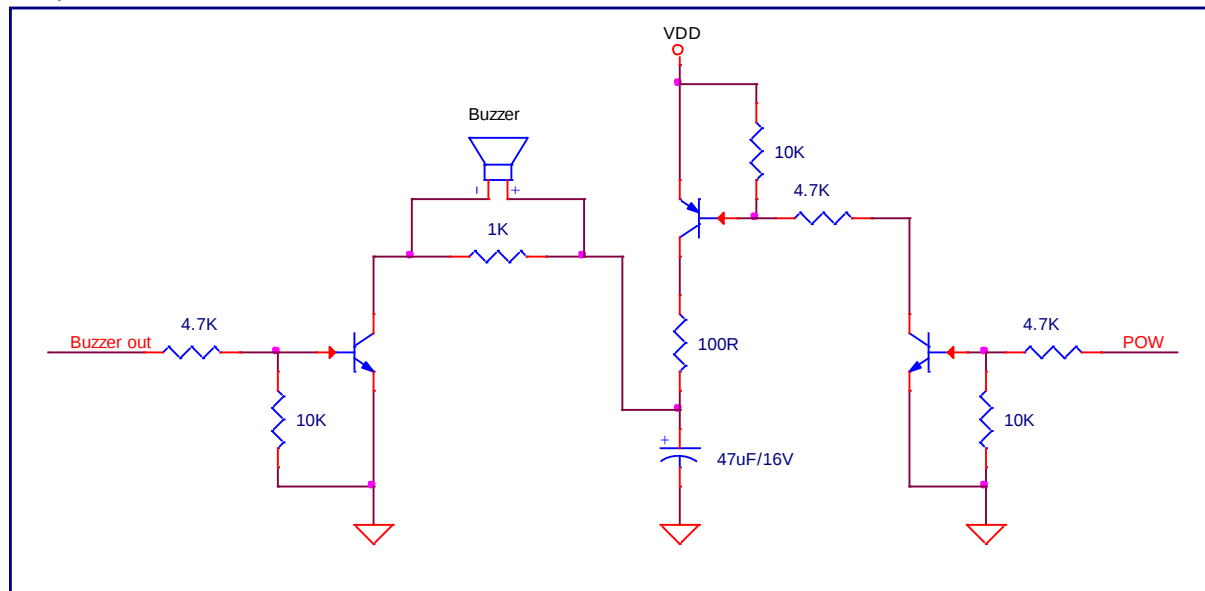


Figure 7 Typical application circuit for Melody

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F8h Buzzer Pin Select Register 1

Bit	D7:D0
Name	BPS1 [7:0]
Default	----- 1

F9h Buzzer Pin Select Register 2

Bit	D0
Name	BPS2 [7:0]
Default	-----

BPS1/2 Buzzer output Select 1/2

BPS2[7:0] unused register.

BPS1[0] maps to KEY0, write 1 will enable KEY0 as Buzzer output

FAh Enable Buzzer Power Register 1

Bit	D7:D0
Name	EBP1 [7:0]
Default	-----

FBh Enable Buzzer Power Register 2

Bit	D0
Name	EBP2 [0]
Default	---- 0 ---

EBP1/2 Buzzer Power Select ½

EBP1[7:0] unused register.

EBP2[3] maps to KEY12, write 1 will enable KEY12 as Buzzer Power

IS32SE5117

GENERAL DESCRIPTION

The IS32SE5117 is an ultra-low power, fully integrated 16-channel solution for capacitive touch-buttons applications. The chip allows electrodes to project sense fields through any dielectric such as glass or plastic.

SENSITIVITY ADJUSTING

Sensitivity can be adjusted by the external capacitor or internal register.

The value of capacitor is higher the sensitivity is lower; value of capacitor is lower the sensitivity is higher.

INTERRUPTION

The changing of action can be signed by the INTB pin. The INTB pin will be pulled low when sensitivity channel is pressed or released.

SHUTDOWN MODE

Shutdown mode can be used as a means of reducing power consumption. During shutdown mode all registers retain their data.

Software Shutdown

By setting SDM bit of the Configuration Register (00h) to "1", the IS32SE5117 will operate in software shutdown mode.

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CLASSIFICATION REFLOW PROFILES

Profile Feature	Pb-Free Assembly
Preheat & Soak Temperature min (T _{smin}) Temperature max (T _{smax}) Time (T _{smin} to T _{smax}) (t _s)	150°C 200°C 60-120 seconds
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.
Liquidous temperature (T _L) Time at liquidous (t _L)	217°C 60-150 seconds
Peak package body temperature (T _p)*	Max 260°C
Time (t _p)** within 5°C of the specified classification temperature (T _c)	Max 30 seconds
Average ramp-down rate (T _p to T _{smax})	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

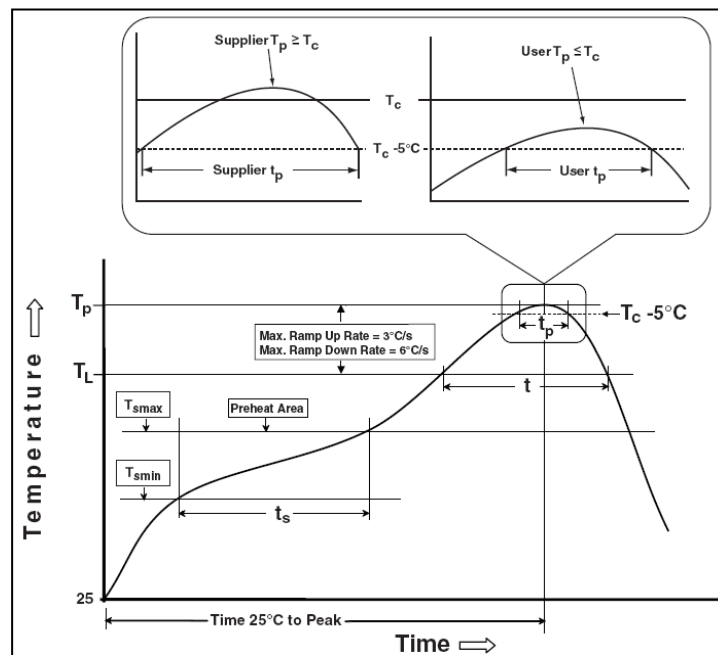


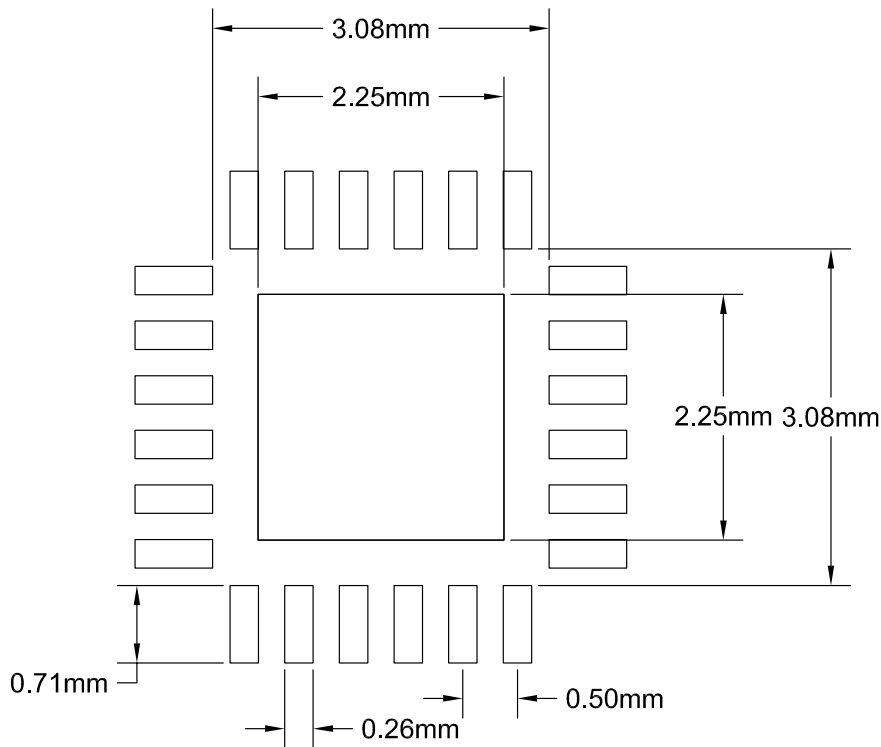
Figure Classification Profile

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PACKAGE INFORMATION

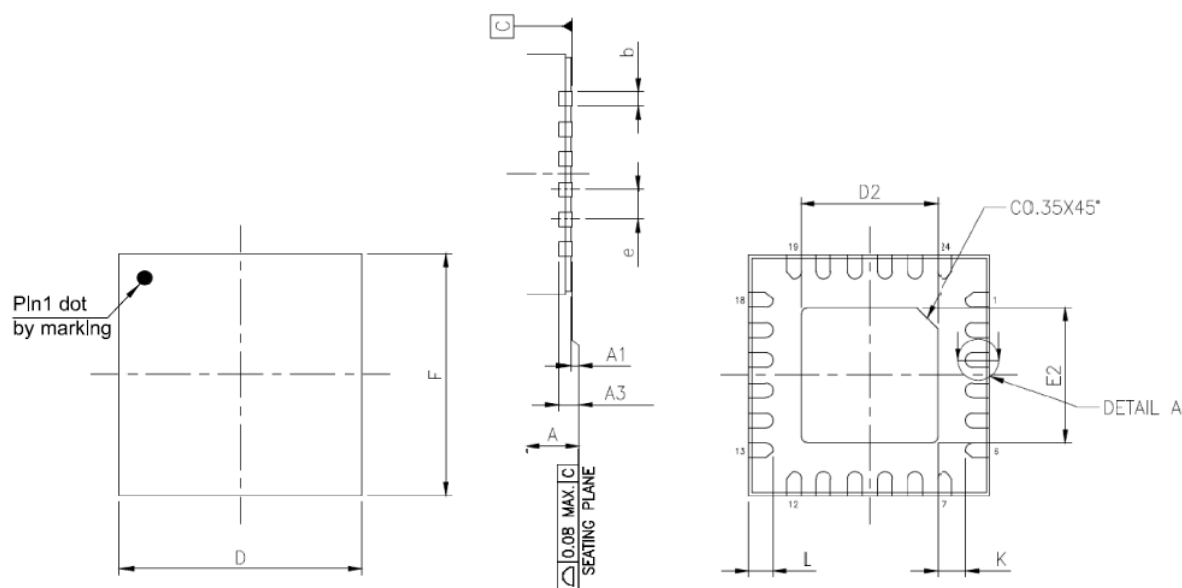
WETTABLE FLANK QFN-24

RECOMMENDED LAND PATTERN

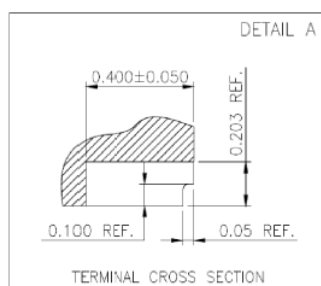


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POD



SYM BOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	0.203 REF.		
b	0.18	0.25	0.30
D	4.0 BSC		
E	4.0 BSC		
D2	2.20	2.25	2.30
E2	2.20	2.25	2.30
L	0.35	0.40	0.45
e	0.50 BSC		
K	0.20	-	-



NOTES:

1. CONTROLLING DIMENSION: MM
2. Reference document: JEDEC MO-220

IS32SE5117

REVISION HISTORY

Revision	Detail Information	Date
A	Initial release.	2021.02.08

Mouser Electronics

Authorized Distributor

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